

# MOS FIELD EFFECT TRANSISTOR

# 2SJ559

## P-CHANNEL MOS FIELD EFFECT TRANSISTOR

## FOR HIGH SPEED SWITCHING

### DESCRIPTION

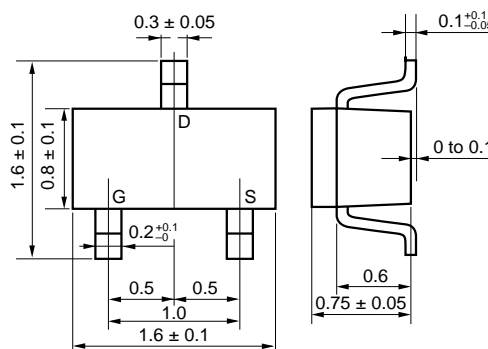
The 2SJ559 is a switching device which can be driven directly by a 2.5 V power source.

The 2SJ559 has excellent switching characteristics, and is suitable for use as a high-speed switching device in digital circuits.

### FEATURES

- Can be driven by a 2.5 V power source.
- Low gate cut-off voltage.

### PACKAGE DRAWING (Unit : mm)



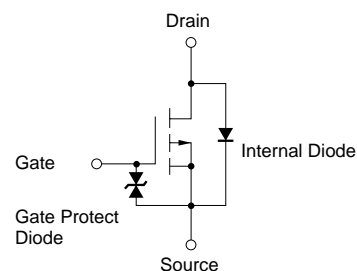
### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Drain to Source Voltage	V <sub>DSS</sub>	-30	V
Gate to Source Voltage	V <sub>GSS</sub>	± 20	V
Drain Current (DC)	I <sub>D(DC)</sub>	± 0.1	A
Drain Current (pulse) <sup>Note1</sup>	I <sub>D(pulse)</sub>	± 0.4	A
Total Power Dissipation <sup>Note2</sup>	P <sub>T</sub>	200	mW
Channel Temperature	T <sub>ch</sub>	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

**Notes 1.** PW ≤ 10 μs, Duty Cycle ≤ 1 %

**2.** Mounted on ceramic substrate of 3.0cm<sup>2</sup> × 0.64 mm

### EQUIVALENT CIRCUIT



Marking : C1

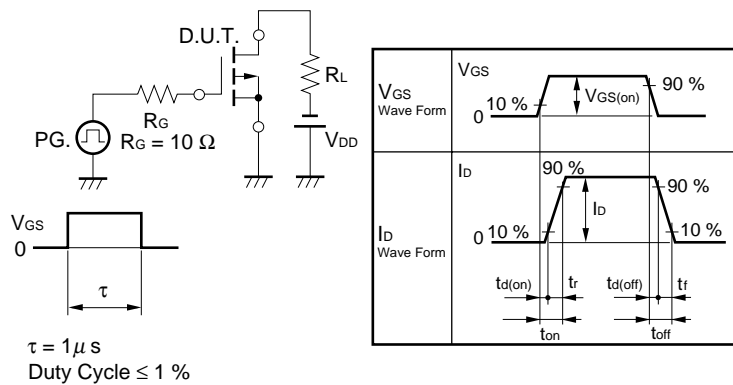
**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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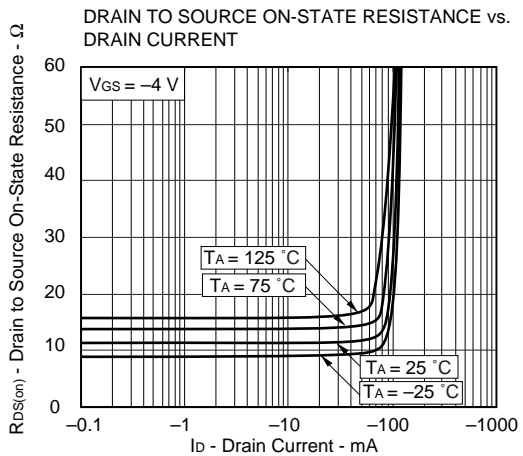
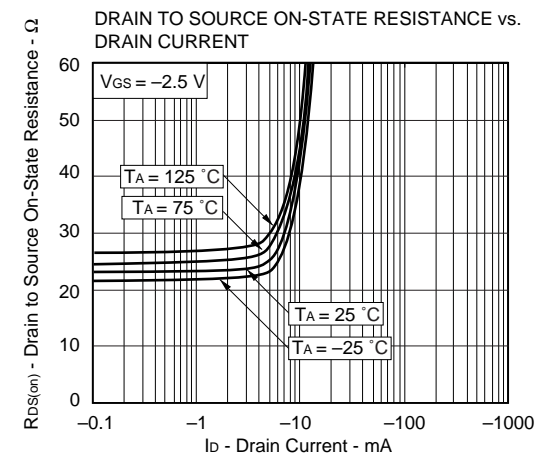
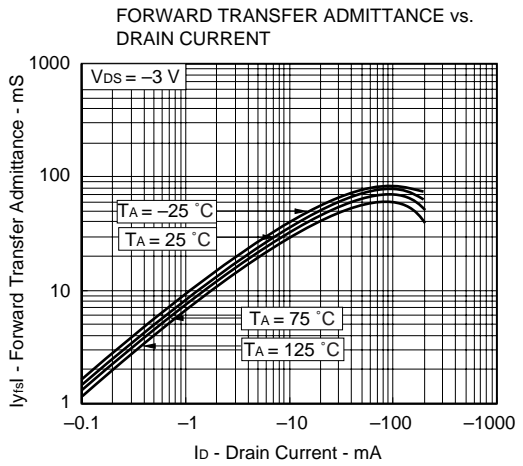
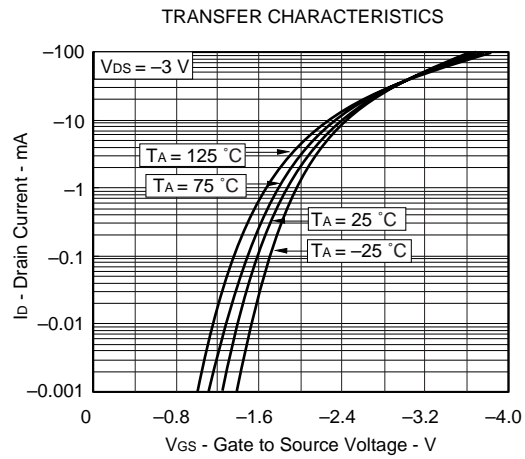
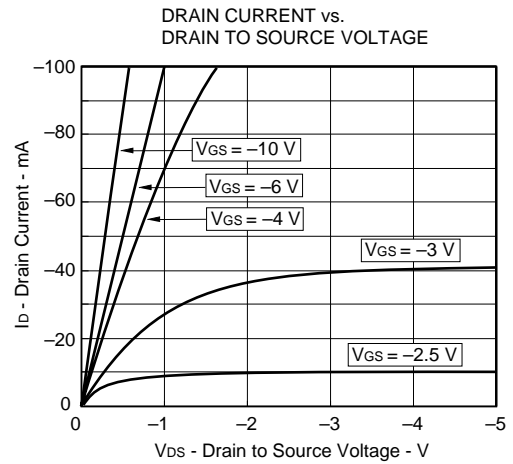
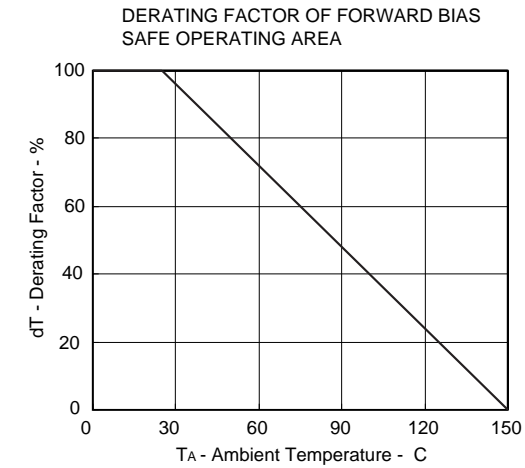
**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)**

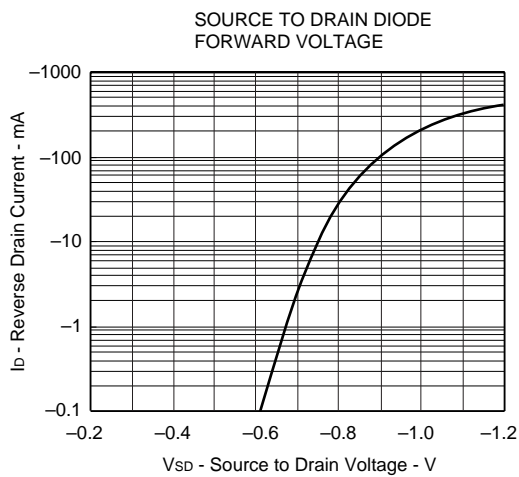
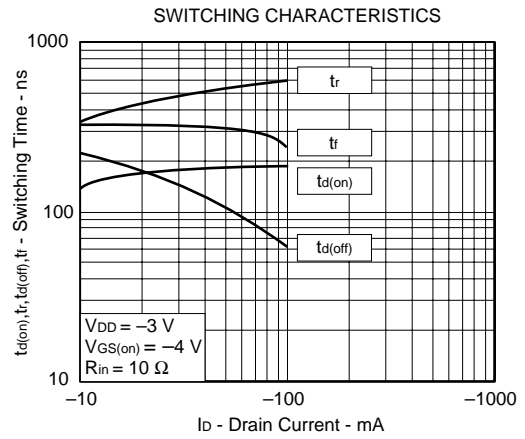
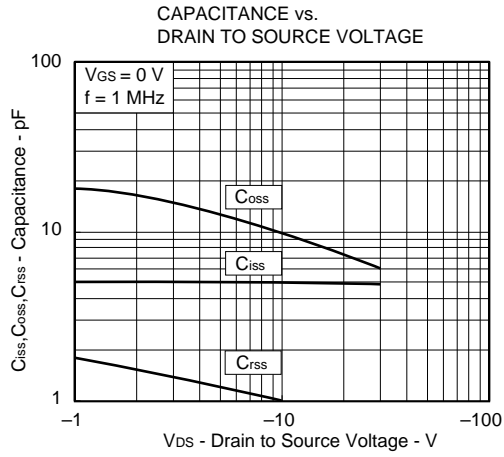
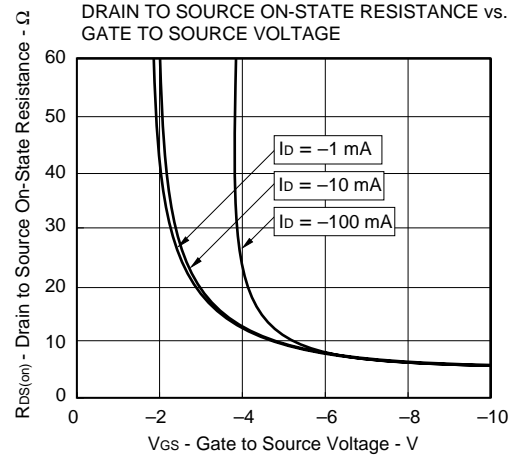
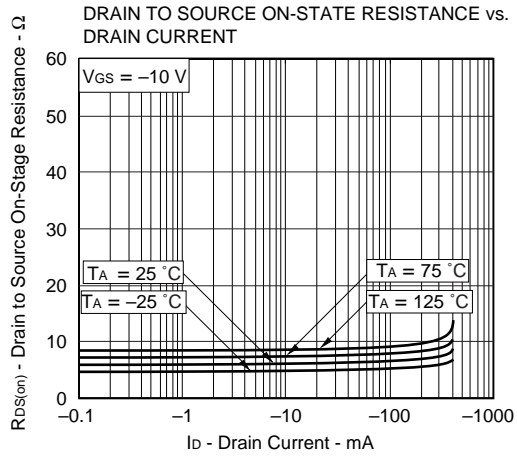
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-off Current	I <sub>DSS</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V			-1	μA
Gate Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V, V <sub>DS</sub> = 0 V			± 10	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = -3 V, I <sub>D</sub> = -10 μA	-1.0	-1.4	-1.7	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = -3 V, I <sub>D</sub> = -10 mA	20			mS
Drain to Source On-state Resistance	R <sub>DS(on)1</sub>	V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -1 mA		23	60	Ω
	R <sub>DS(on)2</sub>	V <sub>GS</sub> = -4 V, I <sub>D</sub> = -10 mA		11	23	Ω
	R <sub>DS(on)3</sub>	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -10 mA		6	13	Ω
Input Capacitance	C <sub>iSS</sub>	V <sub>DS</sub> = -3 V		5		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V		15		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		1.3		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -3 V		140		ns
Rise Time	t <sub>r</sub>	I <sub>D</sub> = -10 mA		330		ns
Turn-off Delay Time	t <sub>d(off)</sub>	V <sub>GS(on)</sub> = -4 V		220		ns
Fall Time	t <sub>f</sub>	R <sub>G</sub> = 10 Ω, R <sub>L</sub> = 300 Ω		320		ns

**TEST CIRCUIT SWITCHING TIME**



TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )





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